

**Amendments to the Specification:**

Please replace the Title section with the following amended Title section:

**DESCRIPTION**

~~Flexible printed circuit board and method for producing the same~~

**TITLE OF THE INVENTION**

Flexible Printed Circuit Board and Method for Producing the Same

**CROSS-REFERENCE TO RELATED APPLICATION**

This application is a Section 371 of International Application No. PCT/JP03/04925, filed April 17, 2003, which was published in the Japanese language on December 18, 2003, under International Publication No. WO 03/105545 A1, the disclosure of which is incorporated herein by reference.